

ON Semiconductor®

NC7SZ00 TinyLogic[®] UHS Two-Input NAND Gate

Features

- Ultra-High Speed: t_{PD} 2.4ns (Typical) into 50pF at 5V V_{CC}
- High Output Drive: ±24mA at 3V V_{CC}
- Broad V_{cc} Operating Range: 1.65V to 5.5V
- Matches Performance of LCX Operated at 3.3V V_{CC}
- Pow er Dow n High-Impedance Inputs/Outputs
- Over-Voltage Tolerance inputs facilitate 5V to 3V Translation
- Proprietary Noise/EMI Reduction Circuitry
- Ultra-Small MicroPak[™] Packages
- Space-Saving SOT23 and SC70 Packages

Description

The NC7SZ00 is a single two-input NAND gate from ON Semiconductor's Ultra-High Speed (UHS) series of TinyLogic[®]. The device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive while maintaining low static power dissipation over a broad V_{CC} operating range. The device is specified to operate over the 1.65V to 5.5V V_{CC} operating range. The inputs and output are high impedance when V_{CC} is 0V. Inputs tolerate voltages up to 6V, independent of V_{CC} operating voltage.

Part Number	Top Mark	Package	Packing Method
NC7SZ00M5X	7Z00	5-Lead SOT23, JEDEC MO-178 1.6mm	3000 Units on Tape & Reel
NC7SZ00P5X	Z00	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3000 Units on Tape & Reel
NC7SZ00L6X	ΥY	6-Lead MicroPak™, 1.00mm Wide	5000 Units on Tape & Reel
NC7SZ00FHX	ΥY	6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch	5000 Units on Tape & Reel

Ordering Information

Connection Diagrams





NC7SZ00 — TinyLogic[®] UHS Two-Input NAND Gate

Pin Configurations

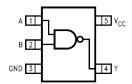


Figure 2. SC70 and SOT23 (Top View)

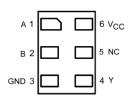


Figure 3. MicroPak™ (Top Through View)

Pin Definitions

Pin # SC70 / SOT23	Pin # MicroPak™	Name	Description
1	1	А	Input
2	2	В	Input
3	3	GND	Ground
4	4	Y	Output
5	6	V _{cc}	Supply Voltage
	5	NC	No Connect

Function Table

Inputs		Output
Α	В	Y
L	L	Н
L	Н	Н
н	L	Н
Н	Н	L

H = HIGH Logic Level

L = LOW Logic Level

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Paramete	Min.	Max.	Unit	
V _{cc}	Supply Voltage			6.0	V
V _{IN}	DC Input Voltage	-0.5	6.0	V	
V _{OUT}	DC Output Voltage	DC Output Voltage			V
	PC Input Diada Current	V _{IN} < -0.5V		-50	m ^
l _{iK}	DC Input Diode Current	V _{IN} > 6.0V		+20	mA

	DC Output Diada Output	V _{OUT} < -0.5V		-50	
ок	DC Output Diode Current	$V_{OUT} > 6V, V_{CC}=GND$		+20	mA
lout	DC Output Current			±50	mA
$I_{\rm CC}$ or $I_{\rm GND}$	DC V_{cc} or Ground Current			±50	mA
T _{STG}	Storage Temperature Range		-65	+150	°C
TJ	Junction Temperature Under Bias			+150	°C
TL	Junction Lead Temperature (Soldering, 10 Seconds)			+260	°C
		SOT-23		200	
P _D	Pow er Dissipation at +85°C	SC70-5		150	mW
۲D		MicroPak™-6		130	1110 0
		MicroPak2™-6		120	
ESD	Human Body Model, JEDEC:JESD22-A114			4000	v
LOD	Charge Device Model, JEDEC:JESD22-0	C101		2000	V

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. ON Semiconductor does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit	
V	Supply Voltage Operating		1.65	5.50	v	
V _{cc}	Supply Voltage Data Retention		1.5	5.5	V	
V _{IN}	Input Voltage		0	5.5	V	
V _{OUT}	Output Voltage		0	V _{cc}	V	
T _A	Operating Temperature		-40	+85	°C	
		V _{cc} at 1.8V, 2.5V ±0.2V	0	20		
t _r , t _f	Input Rise and Fall Times	V _{cc} at 3.3V ± 0.3V	0	10	ns/V	
		V_{cc} at 5.0V ± 0.5V	0	5		
		SOT-23		300		
0	Thermal Desistence	SC70-5		435		
θ_{JA}	Thermal Resistance	MicroPak™-6		500	°C/W	
		MicroPak2™-6		560		

Note:

1. Unused inputs must be held HIGH or LOW. They may not float.

0	Demonster (Condition -	Г	_A =25°(0	T _A =-40 t	o +85°C	L ha it -
Symbol Parameter	Parameter	V _{cc}	Conditions	Min.	Тур.	Max.	Min.	Max.	Units
M	HIGH Level Input	1.65 to 1.95		$0.75V_{\text{CC}}$			$0.75V_{\text{CC}}$		
VIH	Voltage	2.30 to 5.50		$0.70V_{\text{CC}}$			$0.70V_{\text{CC}}$		V
N/	LOW Level Input	1.65 to 1.95				$0.25V_{\text{CC}}$		$0.25V_{\text{CC}}$	V
VIL	Voltage	2.30 to 5.50				$0.30V_{\text{CC}}$		$0.30V_{\text{CC}}$	V
		1.65		1.55	1.65		1.55		
		1.80		1.70	1.80		1.70		
		2.30	V _{IN} =V _{IL} I _{OH} =-100µА	2.20	2.30		2.20		
V _{он} HIGH Level Voltage		3.00		2.90	3.00		2.90		
	HIGH Level Output Voltage	4.50		4.40	4.50		4.40		V
		1.65	I _{OH} =-4mA	1.29	1.52		1.29		
		1.80	I _{OH} =-8mA	1.90	2.15		1.90		
		2.30	I _{OH} =-16mA	2.40	2.80		2.40		
		3.00	I _{OH} =-24mA	2.30	2.68		2.30		
		4.50	I _{OH} =-32mA	3.80	4.20		3.80		
		1.65			0.00	0.10		0.08	
		2.30			0.00	0.10		0.10	
		3.00	V _{IN} =V _{IH} I _{OL} =100µA		0.00	0.10		0.10	
		3.00			0.00	0.10		0.10	
N/	LOW Level Output	4.50			0.00	0.10		0.10	V
Vol	Voltage	1.65	I _{OL} =4mA		0.80	0.24		0.24	V
		2.30	I _{OL} =8mA		0.10	0.30		0.30	
		3.00	I _{OL} =16mA		0.15	0.40		0.40	
		3.00	I _{OL} =24mA		0.22	0.55		0.55	
		4.50	I _{OL} =32mA		0.22	0.55		0.55	
I _{IN}	Input Leakage Current	0 to 5.5	V _{IN} =5.5V, GND			±1		±10	μA
I _{OFF}	Power Off	0	V_{IN} or V_{OUT} =5.5V			1		10	μA
I _{CC}	Quiescent Supply Current	1.65 to 5.50	V _{IN} =5.5V, GND			2		20	μA

AC Ele	AC Electrical Characteristics										
Symbol				T,	₄=25°C		T _A =-40 to +85°C		Units	Figure	
Symbol	Parameter	V _{cc}	Conditions	Min.	Тур.	Max.	Min.	Max.	Units	Figure	
	-	1.65		2.0	5.4	11.4	2.0	12.0			
		1.80	$R_{L}=1$ MIS2	2.0	4.5	9.5	2.0	10.0	ns		
		2.50 ± 0.20		0.8	3.0	6.5	0.8	7.0			
$t_{\text{PHL}}, t_{\text{PLH}}$	Propagation Delay	3.30 ± 0.30		0.5	2.4	4.5	0.5	4.7		ns	Figure 4 Figure 5
		5.00 ± 0.50		0.5	2.0	3.9	0.5	4.1		0	
		3.30 ± 0.30	C∟=50pF,	1.5	2.9	5.0	1.5	5.2			
	5.00 ± 0	5.00 ± 0.50	R _L =500Ω	0.8	2.4	4.3	0.8	4.5			
CIN	Input Capacitance	0.00			4				pF		
CPD	Power Dissipation	3.30			24				ηE	Figure 6	
CPD	Capacitance ⁽²⁾	5.00			30				рF		

Note:

2. C_{PD} is defined as the value of the internal equivalent capacitance derived from dynamic operating current consumption (I_{CCD}) at no output lading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD}=(C_{PD})(V_{CC})(f_{IN})+(I_{CC}\text{static})$.

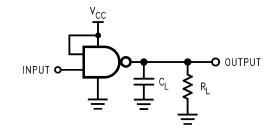
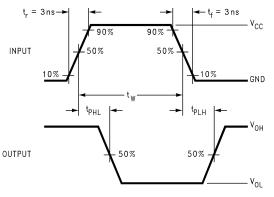
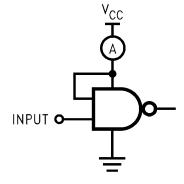


Figure 4. AC Test Circuit







Note:

3. Input=AC Waveform; t_r=t_f=1.8ns; PRR=10MHz; Duty Cycle =50%.

Figure 6. I_{CCD} Test Circuit

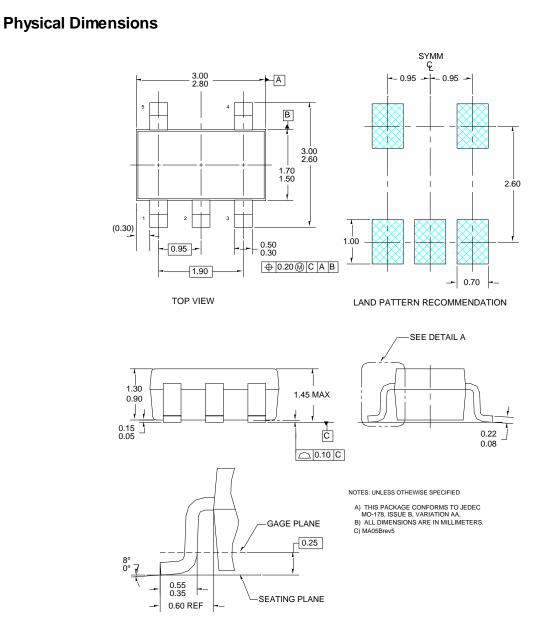


Figure 7. 5-Lead SOT23, JEDEC MO-178 1.6mm

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Tape and Reel Specifications

Package Designator	Tape Section	on Cavity Number Cavity Status		Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
M5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

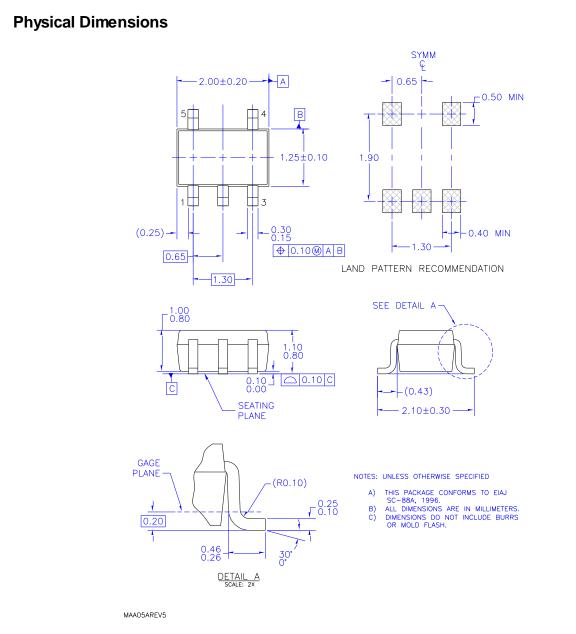
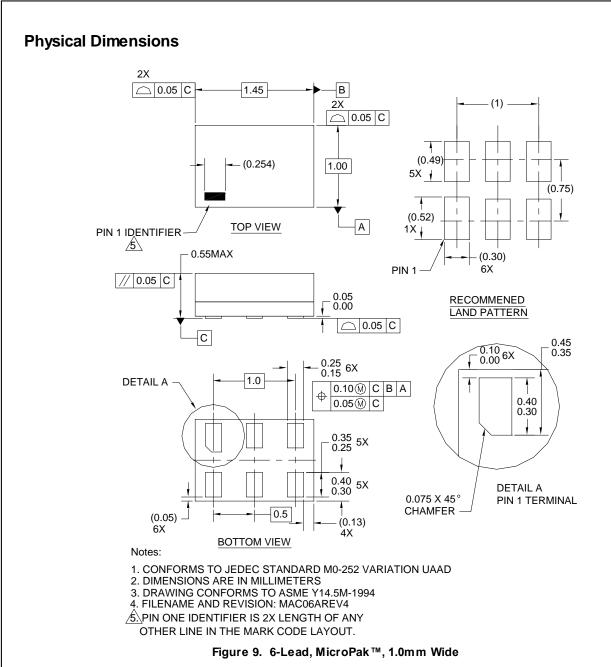


Figure 8. 5-Lead, SC70, EAJ SC-88a, 1.25mm Wide

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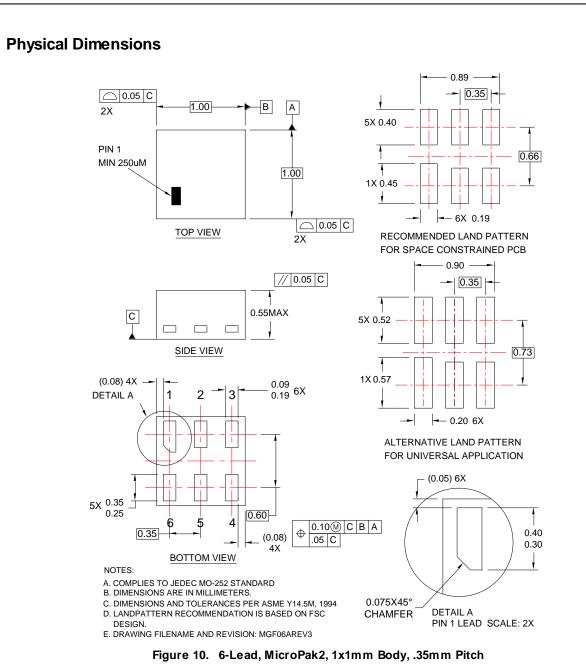
Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
P5X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed



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Tape and Reel Specifications

Package Designator	Tape Section	be Section Cavity Number Cavity Status		Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
L6X	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed



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Tape and Reel Specifications

Package Designator	Tape Section	e Section Cavity Number Cavity Status		Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
FHX	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

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